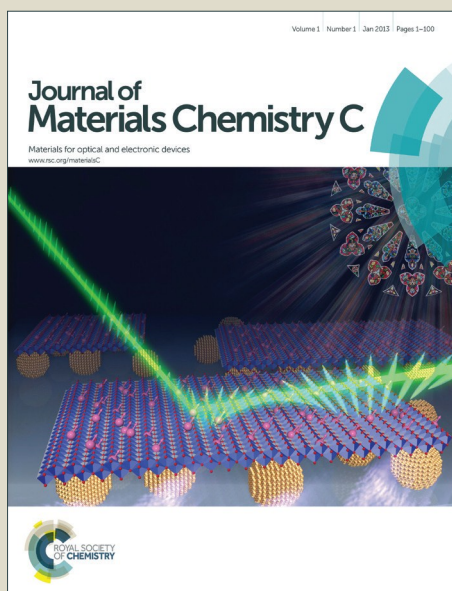


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## ARTICLE

Engineering the energy gap near the valence band edge in Mn-incorporated  $\text{Cu}_3\text{Ga}_5\text{Te}_9$  for an enhanced thermoelectric performanceJiaolin Cui<sup>1\*</sup>, Zheng Sun<sup>1,2</sup>, Zhengliang Du<sup>1</sup>, Yimin Chao<sup>3\*</sup>Cite this: DOI:  
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$\text{Cu}_3\text{Ga}_5\text{Te}_9$  – based compounds  $\text{Cu}_{3-x}\text{Ga}_5\text{Mn}_x\text{Te}_9$  ( $x=0-0.2$ ) with Mn substitution for Cu have been synthesized. The engineered energy gap ( $\Delta E_A$ ) between impurity and valence band is reduced from 44.4 meV at  $x=0$  to 25.7 meV at  $x=0.1$ , which is directly responsible for the reduction of potential barrier for thermal excitation of carriers and enhancement in carrier concentration. However, the Seebeck coefficient shows an increasing tendency with the increasing of determined Hall carrier concentration ( $n$ ). This anomalous behavior suggests that the Pisarenko plots under assumed effective masses do not fit the current relationship between the Seebeck coefficient and carrier density. With the combination of enhanced electrical conductivities and reduced thermal conductivities at high temperatures, the maximum thermoelectric (TE) figure of merit ( $ZT$ ) of 0.81 has been achieved at 804 K with  $x=0.1$ , which is about 1.65 and 2.9 times the value of current and reported intrinsic  $\text{Cu}_3\text{Ga}_5\text{Te}_9$ . The remarkable improvement in TE performance proves that we have succeeded in engineering the energy gap near the valence band edge upon Mn incorporation in  $\text{Cu}_3\text{Ga}_5\text{Te}_9$ .

## 1. Introduction

Thermoelectric (TE) material is capable of converting heat to electricity without using moving mechanical components or hazardous working fluids, and its TE performance is mainly evaluated by the figure of merit ( $ZT$ ),  $ZT=T\alpha^2\sigma/\kappa$ , where  $T$  is absolute temperature,  $\alpha$  is the Seebeck coefficient,  $\sigma$  is the electrical conductivity and  $\kappa$  is the thermal conductivity consisting of electronic ( $\kappa_e$ ) and lattice ( $\kappa_L$ ) components.

In addition to tellurides,<sup>1-3</sup> half-Heuslers<sup>4,5</sup> and silicides<sup>6,7</sup> developed as potential TE materials, the ternary chalcopyrite – structured systems based on Cu – Ga(In) – Te semiconductors have attracted much attention in recent years due to their unique crystal structures.<sup>8-10</sup> However, the TE performance for most of these intrinsic chalcopyrites is rather low because the decreasing rate of the Hall mobility ( $\mu$ ) is larger than that of the  $\kappa_L$ , though the presence of vacancies could reduce the Hall mobility and the lattice thermal conductivity simultaneously.<sup>11</sup>

Among  $(\text{Cu}_2\text{Te})_{1-y}(\text{Ga}_2\text{Te}_3)_y$  material type,  $\text{Cu}_3\text{Ga}_5\text{Te}_9$  ( $y=0.625$ ) (CGT) is one of the chalcopyrite – structured pseudobinary alloys with non-stoichiometric composition.<sup>12,13</sup> It is a potential candidate for TE materials because it possesses a relatively optimal carrier (hole) concentration  $n$  ( $\sim 10^{25} \text{ m}^{-3}$ )<sup>12,14</sup> at room temperature (RT). However, this compound has an ordered array of defect pairs

$\text{Ga}_{\text{Cu}^{2+}}^{2+} + 2\text{V}_{\text{Cu}^-}$  (metal Ga – on – Cu antisites and two Cu vacancies), which remarkably scatters charge carriers,<sup>15,16</sup> leading to the reduction in mobility  $\mu$  (as low as  $7.70 \text{ cm}^2/\text{Vs}$  at RT). In addition, the thermal conductivity of this material is in a region of high levels ( $\sim 2.6 \text{ WK}^{-1}\text{m}^{-1}$  at RT and  $\sim 1.7 \text{ WK}^{-1}\text{m}^{-1}$  at  $\sim 740\text{K}$ ),<sup>12</sup> resulting in a poor TE performance ( $ZT \sim 0.3$  at 740K).<sup>12</sup>

Since Mn is an active element with low electronegativity (1.55), its oxidation states vary differently with chemical compounds and synthesis technologies. Therefore, it is usually used as a guest element to substitute host atoms.<sup>17</sup> In addition, if the chemical control over carrier density in  $\text{Cu}_3\text{Ga}_5\text{Te}_9$  (CGT) can be achieved simply by element substitution, the carrier density in Mn-substituted CGT ( $\text{Cu}_{3-x}\text{Ga}_5\text{Mn}_x\text{Te}_9$ ) can be estimated using the valence counting rule,<sup>18</sup> according to the chemical/crystal environment described below, presumably upon divalent  $\text{Mn}^{2+}$  occupation in the  $\text{Cu}^+$  or  $\text{Ga}^{3+}$  sites respectively,

(upon divalent  $\text{Mn}^{2+}$  occupation in  $\text{Cu}^+$  site)(upon divalent  $\text{Mn}^{2+}$  occupation in  $\text{Ga}^{3+}$  site)

where  $V_{\text{Cu},x}$  is the extra Cu vacancy from the deficiency of Cu, and  $e_x$  and  $h_x$  are the extra electrons and holes.

According to the formulas (1) and (2), an occupation of  $\text{Mn}^{2+}$  in  $\text{Ga}^{3+}$  site can enhance the hole concentration, due to the creation of an acceptor defect  $\text{Mn}_{\text{Ga}}^- (h_x)$ . While the occupation in  $\text{Cu}^+$  site has no net contribution to the carrier density, because the generated extra copper vacancies  $V_{\text{Cu},x}$  from the deficiency of Cu are neutralized by the created defect  $\text{Mn}_{\text{Cu}}^+$  acting as a donor. However, if a high valence Mn ion (e.g.  $\text{Mn}^{4+}$ ) is created in the environment of CGT, it is envisaged that there is a decreased p-type carrier concentration wherever  $\text{Mn}^{4+}$  occupies either  $\text{Cu}^+$  or  $\text{Ga}^{3+}$  site, although there is one-ninth intrinsic vacancy in CGT.<sup>11</sup>

Although such a chemical control has already been achieved in several Cu(Ag) – ternary chalcopyrites,<sup>19,20</sup> this control has not succeed in other materials yet. The reason is the formation of deep impurity level below / above the conduction / valence band,<sup>21,22</sup> which makes the Pisarenko plot<sup>14</sup> inconsistent with the fitting of the relationship between Seebeck coefficient and carrier density. For example, through the formation of new sub-bands near the original conduction or valence band edge the Seebeck coefficient ( $\alpha$ ) can be sharply increased via highly mismatched element substitutions,<sup>23,24</sup> without significant reduction of carrier concentration. Therefore, the modification of the band structures near Fermi level might be an alternative strategy to design high TE performance materials, in addition to the chemical control approach.

In the present work, a series of Cu-poor CGT with Mn substitution for Cu ( $\text{Cu}_{3-x}\text{Ga}_5\text{Mn}_x\text{Te}_9$ ) have been synthesized, and a distinct strategy to improve the TE performance has been explored. With engineered energy gap ( $\Delta E_A$ ) between impurity level and valence band or formation of relatively shallow impurity level, a significantly enhanced figure of merit ( $ZT=0.81 @ 804 \text{ K}$ ) has therefore been achieved. This  $ZT$  value is about 2.9 times that of intrinsic CGT<sup>12</sup> and 0.21 higher than that in Sb-incorporated CGT.<sup>17</sup>

## 2. Experimental

A certain amount of materials Cu, Ga, Te, MnTe with the purity of 5N, according to the chemical formula of  $\text{Cu}_{3-x}\text{Ga}_5\text{Mn}_x\text{Te}_9$  ( $x=0, 0.05, 0.1, 0.2$ ), were loaded into four different vacuum silica tubes respectively, prior to being melted at 1323 K for 96 h, followed by a slow cooling process to RT in furnace.

The Hall coefficient ( $R_H$ ) measurements at RT  $\sim 390 \text{ K}$  were conducted on a Physical Property Measurement System (PPMS, Model-9) using a four probe configuration with a magnetic field sweeping between  $\pm 1.5 \text{ T}$ , and were performed on rectangular samples with size  $2 \times 2 \times 7 \text{ mm}^3$ . The Hall mobilities ( $\mu$ ) and carrier concentrations ( $n$ ) were subsequently calculated from the relations  $\mu = R_H \sigma$  and  $n = 1/(eR_H)$  respectively, where  $e$  is the electron charge. The current and Hall voltage leads were fine copper wires, and the contacts were made of silver paste. The thermal diffusivities were measured using TC-1200RH at RT  $\sim 810 \text{ K}$  and the heat capacities ( $C_p$ ) were estimated according to the relation  $C_p = C_v + BT$  for the

Cu–Ga–Te compounds, where the fitted  $B$  value is determined to be  $0.015 \text{ J mol}^{-1}\text{K}^2$ ,<sup>25</sup> when the  $C_v$  approaches the Dulong–Petit limit.

Detailed experimental procedures, including the preparation of the samples, compositional (EPMA) and measurements of physical parameters ( $\alpha$ ,  $\sigma$ , absorption coefficients  $A$ , Raman spectra and the XPS spectra of above four elements, etc.), have been reported in literatures.<sup>26,27</sup>

## 3. Results and discussions

### 3.1 XRD and composition analyses

The x-ray diffraction patterns (Fig.S1) of titled powders show the peak positions from Mn-added samples are the same as those from intrinsic CGT, indicating the synthesized samples are crystallized in a single phase, in agreement with the results reported in Ref. [12]. Alternatively, the absence of additional peaks on the XRD patterns may indicate the formation of impurity phases that are soluble within the CGT matrix. Since  $\text{Cu}_3\text{Ga}_5\text{Te}_9$  possesses chalcopyrite structure with the space group  $I-42d$ ,<sup>11</sup> one can calculate the lattice parameters  $a$  and  $c$  from the XRD patterns, and estimate the anion displacement parameter ( $u$ ) and tetragonal deformation ( $\eta$ ),<sup>28,29</sup> as well as the mean cation-Te distances ( $R_{\text{Cu-Te}}$  and  $R_{\text{Ga-Te}}$ ).<sup>30,31</sup>

The chemical compositions for intrinsic CGT and Mn-incorporated CGT ( $x=0.2$ ) taken from a mapping of EPMA are shown in Table S1, where the number of Te moles is normalized to 9. The mapping pictures and line scan of  $\text{Cu}_{3-x}\text{Ga}_5\text{Mn}_x\text{Te}_9$  ( $x=0.2$ ) is presented in Fig.S2, and an insert in Fig.S2b is the energy dispersive x-ray spectrum. In Table S1 the relative molars of Cu, Ga, Te identified are close to those of as-prepared materials, except for a little deficiency in Mn. Such a deficiency might be due to limited instrument accuracy ( $\sim 97\%$ ), which does not allow the exact amount of Mn in samples to be collected. In addition, the line scan analysis has revealed an almost homogeneous distribution of four elements in the matrix, as displayed in Fig.S2e,f.

Fig.1(a) shows the measured lattice constants, where an almost linear decreasing of the lattice constants  $a$  and  $c$  against the increasing of  $x$  value is observed. The fitting of relationship between the lattice constants and Mn content  $x$  follows Vegard's law, which suggests that Mn is incorporated into the crystal lattice in  $\text{Cu}_3\text{Ga}_5\text{Te}_9$ . Fig.1(b) are the  $u$  and  $\eta$  values. With Mn content increasing, the  $u$  value sharply increases from 0.2493 ( $x=0$ ) to 0.2560 ( $x=0.1$ ), and then decreases to 0.2542 ( $x=0.2$ ); while the  $\eta$  value reduces from 1.001 ( $x=0$ ) to 0.9870 ( $x=0.1$ ) and then increases to 0.9914 ( $x=0.2$ ). It is obvious that the deviation of  $u$  ( $\eta$ ) values from 0.25 (1.0) at  $x=0.1$  is much higher than others, which indicates that at  $x=0.1$  the crystal distortion is the largest. These results can also be evidenced by the largest difference of the cation-Te distances ( $\Delta d$ ) between  $R_{\text{Cu-Te}}$  and  $R_{\text{Ga-Te}}$ , see Fig.1(c)

### 3.2 XPS analysis

In order to understand the valence charges of the elements in the lattice of  $\text{Cu}_{3-x}\text{Ga}_5\text{Mn}_x\text{Te}_9$ , the oxidation states of Cu, Ga, Mn, and Te are investigated by using  $\text{Cu}2p_{3/2}$ ,  $\text{Ga}2p$ ,  $\text{Mn}2p_{3/2}$ , and  $\text{Te}3d_{5/2}$  XPS spectra at  $x=0$  and 0.2, which are shown in Fig.S3. The average binding energy (BE) values with uncertainties at  $\sim\pm 0.01$  eV are listed in Table 1, in which the BE values of  $\text{Cu}2p_{3/2}$  and  $\text{Te}3d_{5/2}$  are around 932.5 eV and 572.7 eV respectively, which confirm the presence of  $\text{Cu}^+$  and  $\text{Te}^{2-}$ .<sup>32,33</sup> The BE value of  $\text{Ga}2p$  at  $x=0.1$  is 1117.8 eV, which is corresponding to  $\text{Ga}^{3+}$ , about 0.3 eV higher than that at  $x=0$ . The higher BE value of  $\text{Ga}2p$  upon Mn incorporation might be related to the strengthened bonding force of Ga-Te. However, the BE value of  $\text{Mn}2p_{3/2}$  is unexpectedly high (642.3 eV), very close to those in  $\text{MnO}_2$  or  $\text{Mn}^{4+}$  (642.2~642.4eV).<sup>33-35</sup> This indicates the existence of  $\text{Mn}^{4+}$  rather than  $\text{Mn}^{2+}$  or  $\text{Mn}^{3+}$ .

In order to have a better understanding on the occupation site of  $\text{Mn}^{4+}$  in the crystal lattice, Raman spectra from three samples ( $x=0.05$ , 0.1 and pure CGT) are shown in Fig.2, where the inset is the magnified plot. Generally, the Raman spectra of Mn-incorporated samples possess the resemblance to that of intrinsic CGT because the modes at  $134.0\text{ cm}^{-1}$ ,  $74\text{ cm}^{-1}$  and  $203.4\text{ cm}^{-1}$  of all the samples remain active. However, the modes at  $122.7\text{ cm}^{-1}$  and  $134.0\text{ cm}^{-1}$  become less pronounced with Mn content increasing, likely due to the increased lattice distortion. It is worth noting that a red-shift with Mn content increasing has been observed, which allows us to qualitatively correlate the frequency shift with the presence of internal stress/strain of the materials. In fact, the Raman shift is related to the strain/stress, where compressive (tensile) stress results in blue (red) shift. Therefore, the observed red shift in the Raman peak at  $134.0\text{ cm}^{-1}$  indicates the presence of tensile stress, which confirms that  $\text{Mn}^{4+}$  (atomic radius 1.79 Å) prefers the Cu to Ga site, owing to larger size of Ga (1.81 Å) than that of Cu (1.57 Å). As such, the above assumed chemical environment (1) and (2) should be adjusted to the following formula,



(upon  $\text{Mn}^{4+}$  occupation in  $\text{Cu}^+$  site)

Therefore, there are two additional free electrons ( $3e_x\text{V}_{\text{Cu},x}$ ) created per each formula unit upon  $\text{Mn}^{4+}$  occupation in  $\text{Cu}^+$  sites.

### 3.3 Thermoelectric transport properties

In order to determine the effects of Mn incorporation in CGT on transport properties, we have measured Hall coefficients  $R_H$ , and then calculated the Hall carrier concentration  $n$  and mobility  $\mu$  at RT~390 K (Fig.3). Fig.3(a) shows the  $R_H$  values are positive, and decrease with the temperature increasing, while the  $n$  values show an opposite trend against temperature in Fig.3(b). The  $n$  value at RT for the Mn-free CGT ( $3.3\times 10^{19}\text{cm}^{-3}$ ), which is lower than those from Ye et al. ( $5.3\times 10^{19}\text{cm}^{-3}$ )<sup>12</sup> and Plirdpring ( $1.5\times 10^{20}\text{cm}^{-3}$ ),<sup>11</sup> enhances with both the temperature and Mn content up to at  $x=0.1$ , and then decreases with further Mn content increasing. However, in current work the  $n$  values at  $x=0.1$  ( $1.20\times 10^{20}\text{cm}^{-3}$  at RT and  $1.66\times 10^{20}\text{cm}^{-3}$  at 390K) are about 3~4 times higher than that of intrinsic CGT. Besides, the  $n$  value for all samples enhances more rapidly before  $T=340\text{K}$  than it does after  $T=340\text{K}$ . Although the mobility ( $\mu$ ) bears

little relevance to the temperature for the Mn-incorporated samples, it decreases rapidly with Mn content increasing until  $x=0.1$ (Fig.3c). The reduction of  $\mu$  at  $x\leq 0.1$  is due to the reduced relaxation time  $\tau$  or increased effective mass  $m^*$ , according to the relationship  $\mu = e\tau/m^*$ . Upon Mn incorporation, the  $\tau$  value reduces owing to the additional charge carrier-ionized impurity scattering and charge carrier scattering by structural defects (formation of donor defects  $\text{Mn}_{\text{Cu}}^{3+}$  and increased vacancies  $\text{V}_{\text{Cu}}^{\cdot}$ ). It is worth noting that the mobility ( $\mu$ ) value ( $3.8\sim 4.0\text{ cm}^2/\text{vs}$ ) at  $x=0.2$  (Fig.3c) is higher than that at  $x=0.1$  due to low carrier density.

With Mn – incorporated CGT, Fig.4(a) shows that the Seebeck coefficients ( $\alpha$ ) are positive for all the samples, indicating p-type semiconducting behavior. Below  $\sim 600\text{ K}$ , the  $\alpha$  value shows an increasing tendency with Mn content increasing until at  $x=0.1$ . However, above  $\sim 600\text{ K}$  it turns out to decrease dramatically with temperature increasing, due to intrinsic excitation of carriers. In Fig.4(b) the electrical conductivity ( $\sigma$ ) remains almost the same below  $\sim 600\text{ K}$ , but increases in high temperature region and reaches the highest point at  $\sim 773\text{K}$ . Meanwhile, the lattice  $\kappa_L$  at 804 K reduces from 0.60 ( $x=0$ ) to 0.12  $\text{WK}^{-1}\text{m}^{-1}$  ( $x=0.1$ ) with Mn content increasing, and then enhances a little at  $x=0.2$  (shown in Fig.4c). The measured thermal diffusivities ( $\lambda$ ), density of sintered samples ( $d$ ), shown in Fig.S4, decrease with temperature (Mn content) increasing. Therefore, the total  $\kappa$  values, which are calculated from the expression,  $\kappa = d\lambda C_p$ , decrease with temperature increasing, as shown in the inset in Fig.4c. However, the  $\kappa$  values are almost the same ( $\sim 0.68\text{ WK}^{-1}\text{m}^{-1}$ ) at 804 K when  $x\geq 0.05$ , because of the variation in electronic component  $\kappa_e$  caused by the variation of  $\sigma$  with Mn content increasing. Nevertheless, the total  $\kappa$  values at  $x\geq 0.05$  are about 0.26  $\text{WK}^{-1}\text{m}^{-1}$  lower than that at  $x=0$ . Combining three physical parameters ( $\alpha$ ,  $\sigma$ ,  $\kappa$ ), the highest  $ZT$  value of 0.81 at 804 K when  $x=0.1$  is obtained, which is 1.65 and 2.9 times higher than that of Mn-free CGT in current work (shown in Fig.4d), and that reported<sup>12</sup> respectively, and 0.21 higher than that in Sb-incorporated  $\text{Cu}_3\text{Ga}_5\text{Te}_9$ .<sup>17</sup>

The enhanced carrier concentration with Mn content could not be resulted from the chemical control over carrier density, because of the generation of extra electrons  $2e_x$  ( $2e_x=3e_x - \text{V}_{\text{Cu},x}$ ) from the creation of donor defect  $\text{Mn}_{\text{Cu}}^{3+}$  when  $\text{Mn}^{4+}$  prefers the Cu sites, according to the formula unit (3). Therefore, the enhancement in carrier density should be attributed to the structural alterations, such as the modification of the band structure or formation of some shallow impurity levels above the valence band maximum (VBM).

In order to explore the band structure modification upon Mn incorporation, the Pisarenko plots are shown in Fig.5, assuming  $m^* = 0.8, 1.5$  and  $3.0m_e$  and  $T=320\text{ K}, 375\text{ K}$  and  $395\text{ K}$  respectively. The data from Plirdpring<sup>11</sup> and Ye<sup>12</sup> are shown for comparison. We observed that the  $\alpha$  values, at 295 K (labeled as dark square ■), 375K (red circle ●) and 390K (blue triangle ▲) respectively from the current work, show an increasing tendency with determined  $n$  value increasing (along the direction of the arrows in Fig.5), but they do not follow the Pisarenko plot, according to which the Seebeck

coefficient should decrease as the carrier concentration  $n$  enhances. This suggests that the previous assumed band structures might alter upon Mn incorporation, therefore, the Pisarenko plots under assumed effective mass do not well fit the relationship between the Seebeck coefficient and carrier density.

Likewise, the systematic increase of the Seebeck coefficient ( $\alpha$ ) with carrier concentration increasing could not be resulted from the energy gap ( $E_g$ ) widening neither, because the measured  $E_g$  value remains almost unchanged ( $E_g \approx -0.94\text{eV}$ ), see Fig.S5. Actually, if only we take a close look at the  $\alpha$  values in Fig.4a, we may find that the maximum  $\alpha$  values as well as the temperatures at which the maximum  $\alpha$  values appear are roughly the same, regardless of the Mn content. This indicates that the  $E_g$  value could not vary much with the composition, based on the estimation using  $E_g = 2e\alpha_{\max}T$ .

In this regard, in order to rationalize the above anomalous changes, we determine the activation energy or energy gap between impurity and valence band ( $\Delta E_A$ ) using first approximation at high temperatures.<sup>21</sup> The expression is simplified to be<sup>15</sup>

$$n_p(T) \approx A(T) \exp\left(-\frac{\Delta E_A}{\kappa_B T}\right) \quad (4)$$

where  $n_p$  is the hole concentration, which can be considered to be total Hall carrier concentration  $n$ , as the contribution  $n_p$  of the impurity band to the total  $n$  is considered to be negligible.<sup>21</sup> While  $A(T)$  are expected to be slowly varying functions of  $T$  and can be considered as a constant. Under these conditions, we attain the  $\Delta E_A$  values from the slope of the fitted lines in Fig.3b, which gradually decrease from 44.4 meV at  $x=0$  to the lowest 25.7 meV at  $x=0.1$ , and then slightly increase to 26.3 meV at  $x=0.2$ . This indicates that the shallow donor or acceptor levels observed in Mn-incorporated CGT are only partially annihilated, which reduces the potential barrier for thermal excitation of carriers. Such an impact of the potential barrier on the existing charge carriers has also been demonstrated in  $\text{Ti}_{0.1}\text{Zr}_{0.9}\text{NiSn}$  Half-Heusler matrix embedded full-Heusler (FH) quantum dots (QDs).<sup>36</sup> Because of the reduction of potential barrier, we thereby have observed the increase in carrier concentration  $n$ ,

while the Seebeck coefficient remains high. The reduction in  $n$  at  $x=0.2$  might be due to the occupation of a large amount of Mn at the Cu site, which creates extra donors defects  $\text{Mn}_{\text{Cu}}^{3+}$ , thus partially neutralizing the p-type holes and increasing the  $\mu$  value.

In ternary chalcopyrites there are at least two factors that govern the  $\kappa_L$  value on an atomic scale: an extra lattice mismatch and crystal structure distortion.<sup>10</sup> Normally, the lattice part  $\kappa_L$  should be reduced with the lattice mismatch (Mn content) increasing. However, the higher lattice part  $\kappa_L$  at  $x=0.2$  than those at  $x=0.1$  above 675 K is due to the reduced point defect scattering of phonons, which is caused by the reduction of the carrier concentration  $n$  via the creation of the donor defects  $\text{Mn}_{\text{Cu}}^{3+}$ . On the other hand, at  $x=0.1$  there are the largest anion displacement and unit cell distortion, which are represented by the  $\Delta u = u - 0.25$  and  $\Delta \eta = \eta - 1.0$  (Fig.1b), coupled with the largest difference between the mean cation-Te distance ( $\Delta d = R_{\text{Cu-Te}} - R_{\text{Ga-Te}}$ ) (Fig.1c). Therefore, it is reasonable that the  $\kappa_L$  at  $x=0.1$  reaches the lowest value.<sup>37</sup> In addition, in Mn-incorporated CGT, the mean Cu-Te distance ( $R_{\text{Cu-Te}}$ ) is much larger than the mean Ga-Te distance ( $R_{\text{Ga-Te}}$ ), which is different from those in I-III-VI<sub>2</sub> systems, such as  $\text{AgInSe}_2$  and  $\text{CuInTe}_2$ .<sup>26,38</sup>

#### 4. Conclusions

In summary, we have synthesized the compound with Mn substitution for Cu in  $\text{Cu}_3\text{Ga}_5\text{Te}_9$ , and observed a reduction in energy gap between impurity and valence band ( $\Delta E_A$ ) at  $x \leq 0.1$ , which yields only partial annihilation between the shallow donor or acceptor levels, and facilitates thermal excitation of carriers as Mn content increases. The reduction in  $\Delta E_A$  value has directly contributed to the enhancement of the carrier concentration  $n$ , although the Seebeck coefficient shows an increasing tendency with Mn content increasing at  $x \leq 0.1$  when  $T < 600\text{K}$ . Coupled with the reduced thermal conductivities at a proper Mn content, we have obtained the maximum  $ZT$  of 0.81 at 804 K. This value is 1.65 and 2.9 times the value of current intrinsic  $\text{Cu}_3\text{Ga}_5\text{Te}_9$  and that reported, and higher than that of Sb-incorporated  $\text{Cu}_3\text{Ga}_5\text{Te}_9$ .

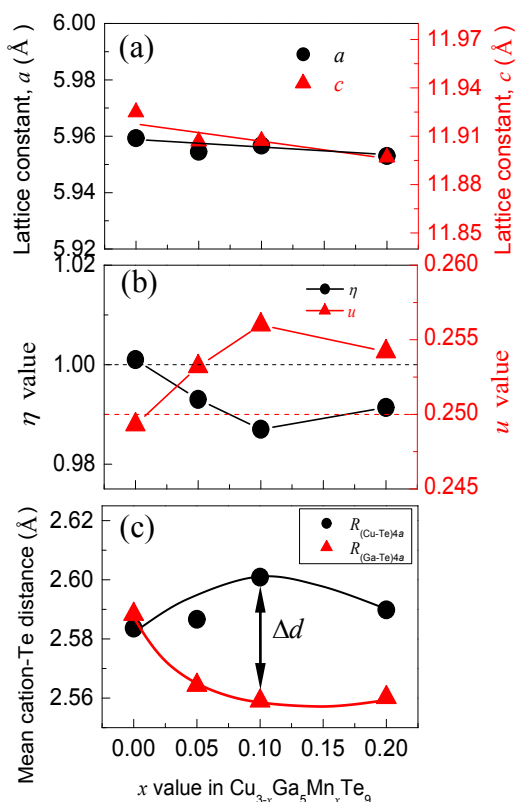


Fig.1 Mn content ( $x$ ) versus lattice parameters ( $a$ ,  $c$ ) (a),  $u$  and  $\eta$  (b), and Mean cation-Te distances  $R_{(\text{Cu-Te})}$  and  $R_{(\text{Ga-Te})}$  (c), where the  $\Delta d = R_{(\text{Cu-Te})} - R_{(\text{Ga-Te})}$ , for Mn-incorporated compounds using X-ray powder diffraction experiment.

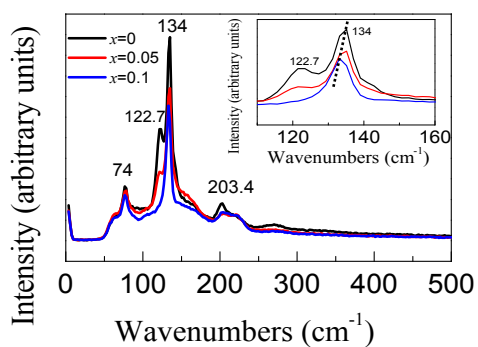


Fig.2 Raman spectra of  $\text{Cu}_{3-x}\text{Ga}_5\text{Mn}_x\text{Te}_9$  ( $x = 0, 0.05$  and  $0.1$ ) samples.

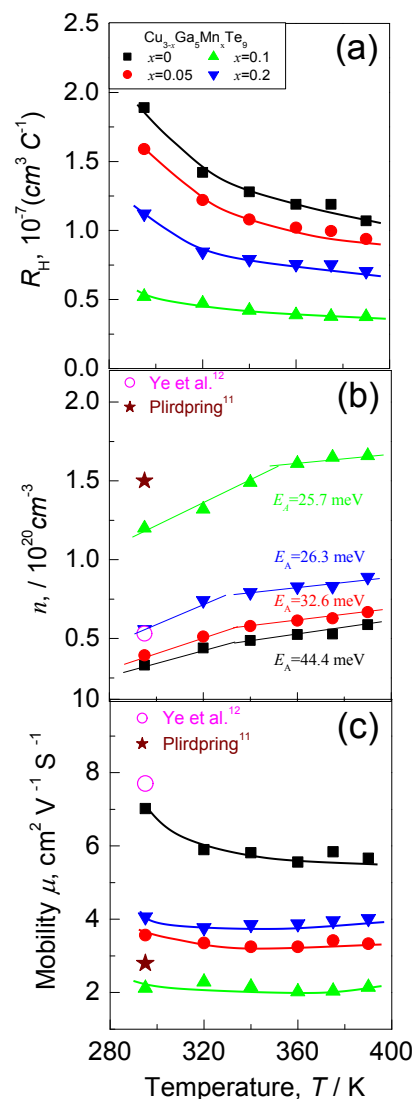


Fig.3 Hall coefficients  $R_H$  (a), Hall carrier concentration ( $n$ ) (b), and mobility ( $\mu$ ) (c) as a function of temperature, where the  $n$  and  $\mu$  values from Plirdpring<sup>11</sup> and Ye<sup>12</sup> are shown for comparison.

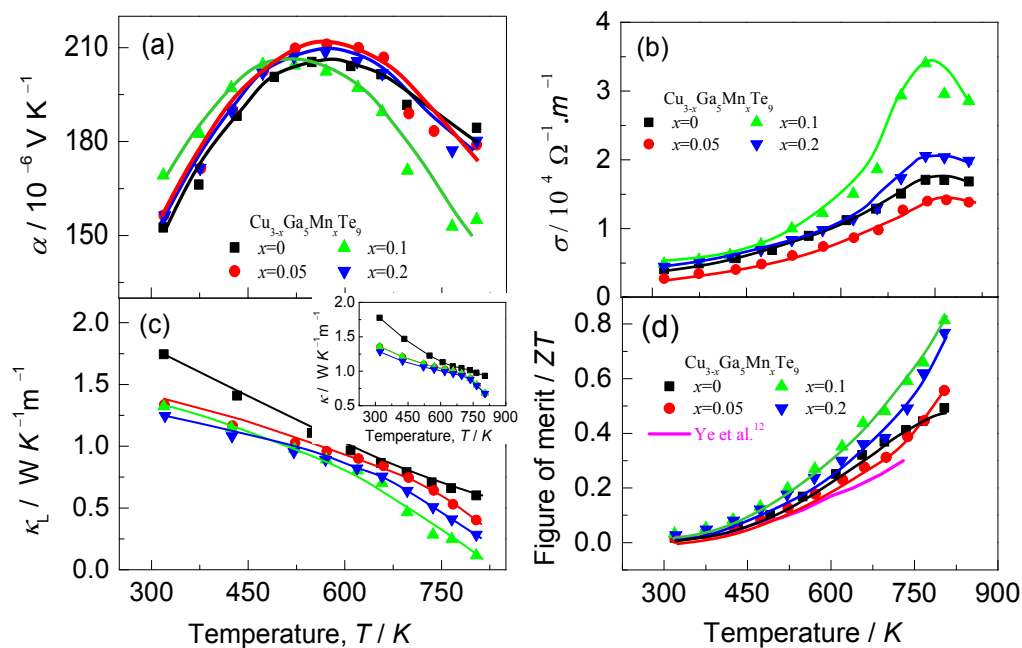


Fig. 4. Thermoelectric properties of Mn-incorporated  $\text{Cu}_3\text{Ga}_5\text{Te}_9$ , (a) Seebeck coefficients ( $\alpha$ ), (b) electrical conductivities ( $\sigma$ ), (c) lattice thermal conductivities ( $\kappa_L$ ) (an inset is the total thermal conductivity ( $\kappa$ )), (d) ZT values, the data from Ye<sup>12</sup> is displayed for comparison.

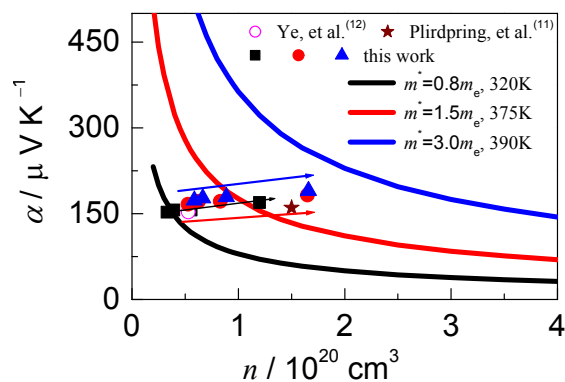


Fig.5 The Pisarenko plots assuming  $m^* = 0.8, 1.5$  and  $3.0m_e$  and  $T=320$  K,  $375$  K and  $395$  K respectively. The data labeled by  $\blacksquare$ ,  $\bullet$  and  $\blacktriangle$  represent the  $\alpha$  values in this work at  $295$ K,  $375$ K and  $390$ K with determined  $n_H$  values. The data from Plirdpring<sup>11</sup> and Ye<sup>12</sup> are shown for comparison.

Table 1 Binding energies of Mn2p, Cu2p, Ga2p, and Te3d core-level photoelectron spectra for  $\text{Cu}_{3-x}\text{Ga}_5\text{Mn}_x\text{Te}_9$  ( $x=0, 0.2$ ) compounds.

Compound	Mn2p <sub>3/2</sub> (eV)	Cu2p <sub>3/2</sub> (eV)	Ga2p (eV)	Te3d <sub>5/2</sub> (eV)
$\text{Cu}_3\text{Ga}_5\text{Te}_9$	-----	932.5	1117.5	572.7
$\text{Cu}_{2.8}\text{Ga}_5\text{Mn}_{0.2}\text{Te}_9$	642.3	932.4	1117.8	572.7

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**Notes and references**

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Electronic Supplementary Information (ESI) available: XRD patterns, EPMA mapping, chemical composition and the absorption coefficients analyses, See DOI: 10.1039/b000000x/



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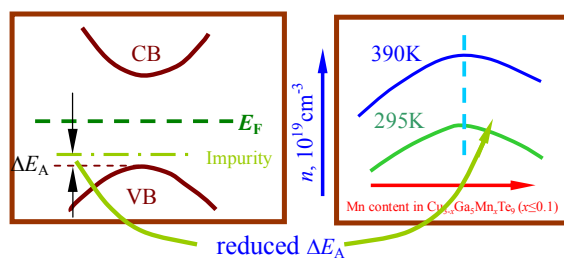
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## Table of Contents (TOC)



Mn substitution for Cu in  $\text{Cu}_3\text{Ga}_5\text{Te}_9$  engineers the energy gap ( $\Delta E_A$ ) between impurity and valence band, which is responsible for the reduction of potential barrier for thermal excitation of carriers.

